



BSI Standards Publication

Device embedding assembly technology

Part 2-10: Design specification for cavity substrate

National foreword

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A list of organizations represented on this committee can be obtained on request to its committee manager.

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CONTENTS

FOREWORD	3
1 Scope	5
2 Normative references	5
3 Terms and definitions	5
4 Objective	5
5 Cavity formation	5
6 Design guideline	6
Annex A (informative) Cavity formation examples	8
A.1 General	8
A.2 Etching type example	8
A.3 Laser type example	9
Figure 1 – Schematic of cavity substrate	6
Figure A.1 – Etching type	8
Figure A.2 – Laser type	9
Table 1 – Cavity formation types	6
Table 2 – Cavity substrate drawing designators	7